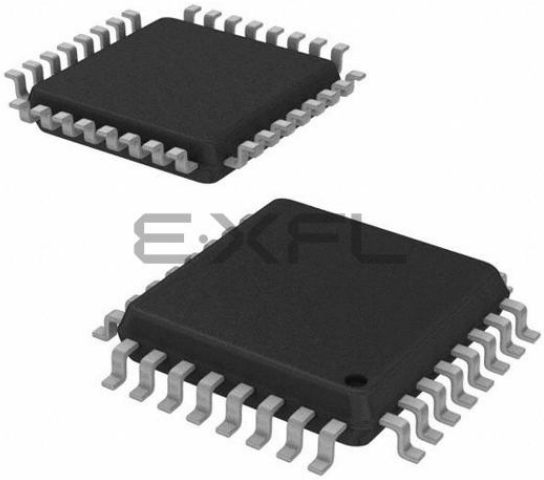

Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	50MHz
Connectivity	SMBus (2-Wire/I²C), SPI, UART/USART
Peripherals	POR, PWM, Temp Sensor, WDT
Number of I/O	25
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.25V
Data Converters	A/D 25x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f567-iqr

Table 5.7. Clock Multiplier Electrical Specifications

V_{DD} = 1.8 to 2.75 V, –40 to +125 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Input Frequency (Fcm_{in})		2	—	—	MHz
Output Frequency		—	—	50	MHz
Power Supply Current		—	0.9	1.9	mA

Table 5.8. Voltage Regulator Electrical Characteristics

V_{DD} = 1.8 to 2.75 V, –40 to +125 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Input Voltage Range (V_{REGIN})		1.8*	—	5.25	V
Dropout Voltage (V_{DO})	Maximum Current = 50 mA	—	10	—	mV/mA
Output Voltage (V_{DD})	2.1 V operation (REG0MD = 0)	2.0	2.1	2.25	V
	2.6 V operation (REG0MD = 1)	2.5	2.6	2.75	
Bias Current		—	1	9	µA
Dropout Indicator Detection Threshold	With respect to VDD	–0.21	—	–0.02	V
Output Voltage Temperature Coefficient		—	0.29	—	mV/°C
VREG Settling Time	50 mA load with V_{REGIN} = 2.4 V and V_{DD} load capacitor of 4.8 µF	—	450	—	µs
***Note:** The minimum input voltage is 1.8 V or V_{DD} + V_{DO}(max load), whichever is greater					

SFR Definition 6.8. ADC0TK: ADC0 Tracking Mode Select

Bit	7	6	5	4	3	2	1	0
Name	AD0PWR[3:0]				AD0TM[1:0]		AD0TK[1:0]	
Type	R/W				R/W		R/W	
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xBA; SFR Page = 0x00

Bit	Name	Function
7:4	AD0PWR[3:0]	**ADC0 Burst Power-up Time.** For BURSTEN = 0: ADC0 Power state controlled by AD0EN For BURSTEN = 1, AD0EN = 1: ADC0 remains enabled and does not enter the very low power state For BURSTEN = 1, AD0EN = 0: ADC0 enters the very low power state and is enabled after each convert start signal. The Power-up time is programmed according the following equation: $AD0PWR = \frac{Tstartup}{200ns} - 1$ or $Tstartup = (AD0PWR + 1)200ns$
3:2	AD0TM[1:0]	**ADC0 Tracking Mode Enable Select Bits.** 00: Reserved. 01: ADC0 is configured to Post-Tracking Mode. 10: ADC0 is configured to Pre-Tracking Mode. 11: ADC0 is configured to Dual Tracking Mode.
1:0	AD0TK[1:0]	**ADC0 Post-Track Time.** 00: Post-Tracking time is equal to 2 SAR clock cycles + 2 FCLK cycles. 01: Post-Tracking time is equal to 4 SAR clock cycles + 2 FCLK cycles. 10: Post-Tracking time is equal to 8 SAR clock cycles + 2 FCLK cycles. 11: Post-Tracking time is equal to 16 SAR clock cycles + 2 FCLK cycles.

6.4. Programmable Window Detector

The ADC Programmable Window Detector continuously compares the ADC0 output registers to user-programmed limits, and notifies the system when a desired condition is detected. This is especially effective in an interrupt-driven system, saving code space and CPU bandwidth while delivering faster system response times. The window detector interrupt flag (AD0WINT in register ADC0CN) can also be used in polled mode. The ADC0 Greater-Than (ADC0GTH, ADC0GTL) and Less-Than (ADC0LTH, ADC0LTL) registers hold the comparison values. The window detector flag can be programmed to indicate when measured data is inside or outside of the user-programmed limits, depending on the contents of the ADC0 Less-Than and ADC0 Greater-Than registers.

8. Comparators

The C8051F55x/56x/57x devices include two on-chip programmable voltage Comparators. A block diagram of the comparators is shown in Figure 8.1, where “n” is the comparator number (0 or 1). The two Comparators operate identically except that Comparator0 can also be used a reset source. For input selection details, refer to SFR Definition 8.5 and SFR Definition 8.6.

Each Comparator offers programmable response time and hysteresis, an analog input multiplexer, and two outputs that are optionally available at the Port pins: a synchronous “latched” output (CP0, CP1), or an asynchronous “raw” output (CP0A, CP1A). The asynchronous signal is available even when the system clock is not active. This allows the Comparators to operate and generate an output with the device in STOP mode. When assigned to a Port pin, the Comparator outputs may be configured as open drain or push-pull (see Section “19.4. Port I/O Initialization” on page 174). Comparator0 may also be used as a reset source (see Section “16.5. Comparator0 Reset” on page 142).

The Comparator0 inputs are selected in the CPT0MX register (SFR Definition 8.5). The CMX0P1-CMX0P0 bits select the Comparator0 positive input; the CMX0N1-CMX0N0 bits select the Comparator0 negative input. The Comparator1 inputs are selected in the CPT1MX register (SFR Definition 8.6). The CMX1P1-CMX1P0 bits select the Comparator1 positive input; the CMX1N1-CMX1N0 bits select the Comparator1 negative input.

Important Note About Comparator Inputs: The Port pins selected as Comparator inputs should be configured as analog inputs in their associated Port configuration register, and configured to be skipped by the Crossbar (for details on Port configuration, see Section “19.1. Port I/O Modes of Operation” on page 170).

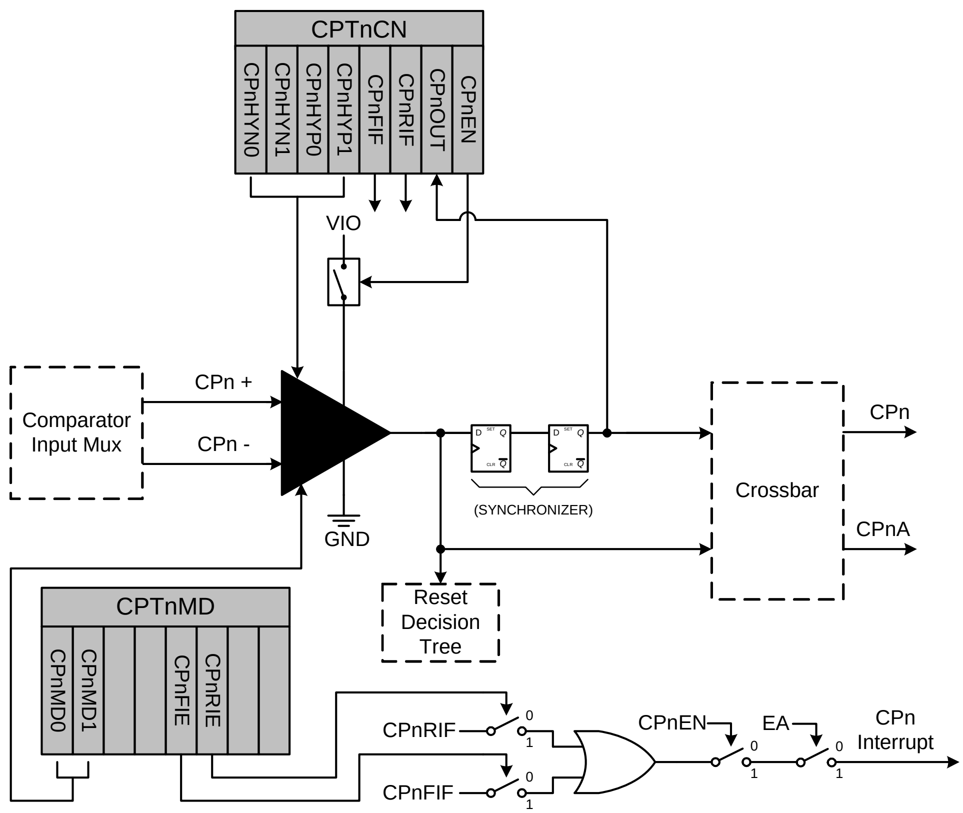

Figure 8.1. Comparator Functional Block Diagram

9. Voltage Regulator (REG0)

C8051F55x/56x/57x devices include an on-chip low dropout voltage regulator (REG0). The input to REG0 at the V_{REGIN} pin can be as high as 5.25 V. The output can be selected by software to 2.1 V or 2.6 V. When enabled, the output of REG0 appears on the V_{DD} pin, powers the microcontroller core, and can be used to power external devices. On reset, REG0 is enabled and can be disabled by software.

The Voltage regulator can generate an interrupt (if enabled by EREG0, EIE2.0) that is triggered whenever the V_{REGIN} input voltage drops below the dropout threshold voltage. This dropout interrupt has no pending flag and the recommended procedure to use it is as follows:

1. Wait enough time to ensure the V_{REGIN} input voltage is stable
2. Enable the dropout interrupt (EREG0, EIE2.0) and select the proper priority (PREG0, EIP2.0)
3. If triggered, inside the interrupt disable it (clear EREG0, EIE2.0), execute all procedures necessary to protect your application (put it in a safe mode and leave the interrupt now disabled.
4. In the main application, now running in the safe mode, regularly checks the DROPOUT bit (REG0CN.0). Once it is cleared by the regulator hardware the application can enable the interrupt again (EREG0, EIE1.6) and return to the normal mode operation.

The input (V_{REGIN}) and output (V_{DD}) of the voltage regulator should both be bypassed with a large capacitor (4.7 µF + 0.1 µF) to ground as shown in Figure 9.1. This capacitor will eliminate power spikes and provide any immediate power required by the microcontroller. The settling time associated with the voltage regulator is shown in Table 5.8 on page 43.

Note: The output of the internal voltage regulator is calibrated by the MCU immediately after any reset event. The output of the un-calibrated internal regulator could be below the high threshold setting of the V_{DD} Monitor. If this is the case *and* the V_{DD} Monitor is set to the high threshold setting *and* if the MCU receives a non-power on reset (POR), the MCU will remain in reset until a POR occurs (i.e., V_{DD} Monitor will keep the device in reset). A POR will force the V_{DD} Monitor to the low threshold setting which is guaranteed to be below the un-calibrated output of the internal regulator. The device will then exit reset and resume normal operation. It is for this reason Silicon Labs strongly recommends that the V_{DD} Monitor is always left in the low threshold setting (i.e. default value upon POR).

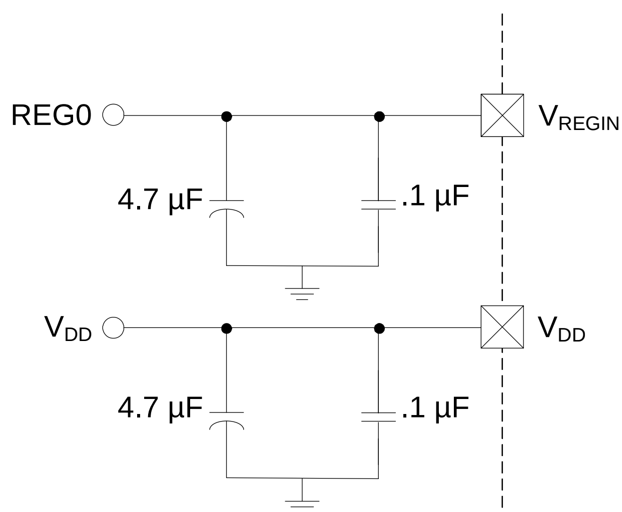

Figure 9.1. External Capacitors for Voltage Regulator Input/Output— Regulator Enabled

SFR Definition 10.3. SP: Stack Pointer

Bit	7	6	5	4	3	2	1	0
Name	SP[7:0]							
Type	R/W							
Reset	0	0	0	0	0	1	1	1

SFR Address = 0x81; SFR Page = All Pages

Bit	Name	Function
7:0	SP[7:0]	**Stack Pointer.** The Stack Pointer holds the location of the top of the stack. The stack pointer is incremented before every PUSH operation. The SP register defaults to 0x07 after reset.

SFR Definition 10.4. ACC: Accumulator

Bit	7	6	5	4	3	2	1	0
Name	ACC[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE0; SFR Page = All Pages; Bit-Addressable

Bit	Name	Function
7:0	ACC[7:0]	**Accumulator.** This register is the accumulator for arithmetic operations.

SFR Definition 10.5. B: B Register

Bit	7	6	5	4	3	2	1	0
Name	B[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF0; SFR Page = All Pages; Bit-Addressable

Bit	Name	Function
7:0	B[7:0]	**B Register.** This register serves as a second accumulator for certain arithmetic operations.

On the execution of the RETI instruction in the CAN0 ISR, the value in SFRPAGE register is overwritten with the contents of SFRNEXT. The CIP-51 may now access the SPI0DAT register as it did prior to the interrupts occurring. See Figure 12.6.

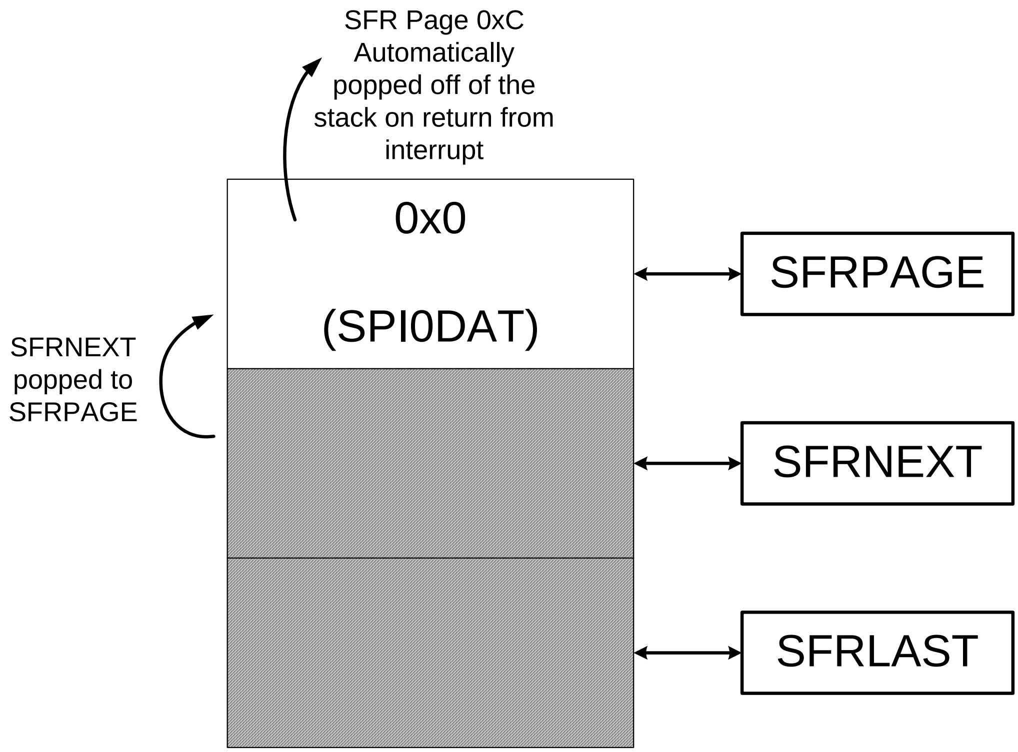

Figure 12.6. SFR Page Stack Upon Return From CAN0 Interrupt

In the example above, all three bytes in the SFR Page Stack are accessible via the SFRPAGE, SFRNEXT, and SFRLAST special function registers. If the stack is altered while servicing an interrupt, it is possible to return to a different SFR Page upon interrupt exit than selected prior to the interrupt call. Direct access to the SFR Page stack can be useful to enable real-time operating systems to control and manage context switching between multiple tasks.

Push operations on the SFR Page Stack only occur on interrupt service, and pop operations only occur on interrupt exit (execution on the RETI instruction). The automatic switching of the SFRPAGE and operation of the SFR Page Stack as described above can be disabled in software by clearing the SFR Automatic Page Enable Bit (SFRPGEN) in the SFR Page Control Register (SFR0CN). See SFR Definition 12.1.

SFR Definition 12.3. SFRNEXT: SFR Next

Bit	7	6	5	4	3	2	1	0
Name	SFRNEXT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x85; SFR Page = All Pages

Bit	Name	Function
7:0	SFRNEXT[7:0]	**SFR Page Bits.** This is the value that will go to the SFR Page register upon a return from interrupt. Write: Sets the SFR Page contained in the second byte of the SFR Stack. This will cause the SFRPAGE SFR to have this SFR page value upon a return from interrupt. Read: Returns the value of the SFR page contained in the second byte of the SFR stack. SFR page context is retained upon interrupts/return from interrupts in a 3 byte SFR Page Stack: SFRPAGE is the first entry, SFRNEXT is the second, and SFRLAST is the third entry. The SFR stack bytes may be used alter the context in the SFR Page Stack, and will not cause the stack to “push” or “pop”. Only interrupts and return from interrupts cause pushes and pops of the SFR Page Stack.

SFR Definition 13.2. IP: Interrupt Priority

Bit	7	6	5	4	3	2	1	0
Name		PSPI0	PT2	PS0	PT1	PX1	PT0	PX0
Type	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	0	0	0	0	0	0	0

SFR Address = 0xB8; Bit-Addressable; SFR Page = All Pages

Bit	Name	Function
7	Unused	Read = 1b, Write = Don't Care.
6	PSPI0	**Serial Peripheral Interface (SPI0) Interrupt Priority Control.** This bit sets the priority of the SPI0 interrupt. 0: SPI0 interrupt set to low priority level. 1: SPI0 interrupt set to high priority level.
5	PT2	**Timer 2 Interrupt Priority Control.** This bit sets the priority of the Timer 2 interrupt. 0: Timer 2 interrupt set to low priority level. 1: Timer 2 interrupt set to high priority level.
4	PS0	**UART0 Interrupt Priority Control.** This bit sets the priority of the UART0 interrupt. 0: UART0 interrupt set to low priority level. 1: UART0 interrupt set to high priority level.
3	PT1	**Timer 1 Interrupt Priority Control.** This bit sets the priority of the Timer 1 interrupt. 0: Timer 1 interrupt set to low priority level. 1: Timer 1 interrupt set to high priority level.
2	PX1	**External Interrupt 1 Priority Control.** This bit sets the priority of the External Interrupt 1 interrupt. 0: External Interrupt 1 set to low priority level. 1: External Interrupt 1 set to high priority level.
1	PT0	**Timer 0 Interrupt Priority Control.** This bit sets the priority of the Timer 0 interrupt. 0: Timer 0 interrupt set to low priority level. 1: Timer 0 interrupt set to high priority level.
0	PX0	**External Interrupt 0 Priority Control.** This bit sets the priority of the External Interrupt 0 interrupt. 0: External Interrupt 0 set to low priority level. 1: External Interrupt 0 set to high priority level.

16.1. Power-On Reset

During power-up, the device is held in a reset state and the $\overline{RST}$ pin is driven low until V_{DD} settles above V_{RST}. A delay occurs before the device is released from reset; the delay decreases as the V_{DD} ramp time increases (V_{DD} ramp time is defined as how fast V_{DD} ramps from 0 V to V_{RST}). Figure 16.2. plots the power-on and V_{DD} monitor reset timing.

On exit from a power-on reset, the PORSF flag (RSTSRC.1) is set by hardware to logic 1. When PORSF is set, all of the other reset flags in the RSTSRC Register are indeterminate (PORSF is cleared by all other resets). Since all resets cause program execution to begin at the same location (0x0000) software can read the PORSF flag to determine if a power-up was the cause of reset. The content of internal data memory should be assumed to be undefined after a power-on reset. The V_{DD} monitor is enabled following a power-on reset.

Note: For devices with a date code before year 2011, work week 24 (1124), if the /RST pin is held low for more than 1 second while power is applied to the device, and then /RST is released, a percentage of devices may lock up and fail to execute code. Toggling the /RST pin does not clear the condition. The condition is cleared by cycling power. Most devices that are affected will show the lock up behavior only within a narrow range of temperatures (a 5 to 10 °C window). Parts with a date code of year 2011, work week 24 (1124) or later do not have any restrictions on /RST low time. The date code of a device is a four-digit number on the bottom-most line of each device with the format YYWW, where YY is the two-digit calendar year and WW is the two digit work week.

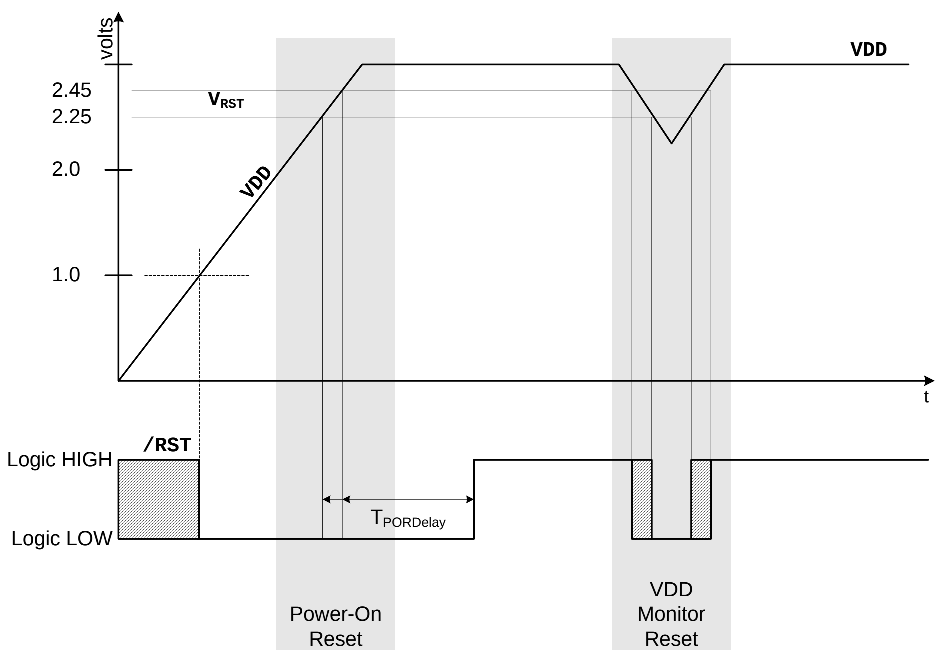

Figure 16.2. Power-On and V_{DD} Monitor Reset Timing

20.7.2. LIN Indirect Access SFR Registers Definitions

Table 20.4 lists the 15 indirect registers used to configured and communicate with the LIN controller.

Table 20.4. LIN Registers* (Indirectly Addressable)

Name	Address	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
LIN0DT1	0x00	DATA1[7:0]							
LIN0DT2	0x01	DATA2[7:0]							
LIN0DT3	0x02	DATA3[7:0]							
LIN0DT4	0x03	DATA4[7:0]							
LIN0DT5	0x04	DATA5[7:0]							
LIN0DT6	0x05	DATA67:0]							
LIN0DT7	0x06	DATA7[7:0]							
LIN0DT8	0x07	DATA8[7:0]							
LIN0CTRL	0x08	STOP(s)	SLEEP(s)	TXRX	DTACK(s)	RSTINT	RSTERR	WUPREQ	STREQ(m)
LIN0ST	0x09	ACTIVE	IDLTOUT	ABORT(s)	DTREQ(s)	LININT	ERROR	WAKEUP	DONE
LIN0ERR	0x0A				SYNCH(s)	PRTY(s)	TOUT	CHK	BITERR
LIN0SIZE	0x0B	ENHCHK				LINSIZE[3:0]			
LIN0DIV	0x0C	DIVLSB[7:0]							
LIN0MUL	0x0D	PRESCL[1:0]		LINMUL[4:0]					DIV9
LIN0ID	0x0E			ID5	ID4	ID3	ID2	ID1	ID0

***Note:** These registers are used in both master and slave mode. The register bits marked with (m) are accessible only in Master mode while the register bits marked with (s) are accessible only in slave mode. All other registers are accessible in both modes.

LIN Register Definition 20.4. LIN0DTn: LIN0 Data Byte n

Bit	7	6	5	4	3	2	1	0
Name	DATAn[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

Indirect Address: LIN0DT1 = 0x00, LIN0DT2 = 0x01, LIN0DT3 = 0x02, LIN0DT4 = 0x03, LIN0DT5 = 0x04, LIN0DT6 = 0x05, LIN0DT7 = 0x06, LIN0DT8 = 0x07

Bit	Name	Function
7:0	DATAn[7:0]	**LIN Data Byte n.** Serial Data Byte that is received or transmitted across the LIN interface.

LIN Register Definition 20.8. LIN0SIZE: LIN0 Message Size Register

Bit	7	6	5	4	3	2	1	0
Name	ENHCHK				LINSIZE[3:0]			
Type	R/W	R	R	R	R/W			
Reset	0	0	0	0	0	0	0	0

Indirect Address = 0x0B

Bit	Name	Function
7	ENHCHK	**Checksum Selection Bit.** 0: Use the classic, specification 1.3 compliant checksum. Checksum covers the data bytes. 1: Use the enhanced, specification 2.0 compliant checksum. Checksum covers data bytes and protected identifier.
6:4	Unused	Read = 000b; Write = Don’t Care
3:0	LINSIZE[3:0]	**Data Field Size.** 0000: 0 data bytes 0001: 1 data byte 0010: 2 data bytes 0011: 3 data bytes 0100: 4 data bytes 0101: 5 data bytes 0110: 6 data bytes 0111: 7 data bytes 1000: 8 data bytes 1001-1110: RESERVED 1111: Use the ID[1:0] bits (LIN0ID[5:4]) to determine the data length.

21. Controller Area Network (CAN0)

Important Documentation Note: The Bosch CAN Controller is integrated in the C8051F550/1/4/5, 'F560/1/4/5/8/9, and 'F572/3 devices. This section of the data sheet gives a description of the CAN controller as an overview and offers a description of how the Silicon Labs CIP-51 MCU interfaces with the on-chip Bosch CAN controller. In order to use the CAN controller, refer to Bosch's C_CAN User's Manual as an accompanying manual to the Silicon Labs' data sheet.

The C8051F550/1/4/5, 'F560/1/4/5/8/9, and 'F572/3 devices feature a Control Area Network (CAN) controller that enables serial communication using the CAN protocol. Silicon Labs CAN facilitates communication on a CAN network in accordance with the Bosch specification 2.0A (basic CAN) and 2.0B (full CAN). The CAN controller consists of a CAN Core, Message RAM (separate from the CIP-51 RAM), a message handler state machine, and control registers. Silicon Labs CAN is a protocol controller and does not provide physical layer drivers (i.e., transceivers). Figure 21.1 shows an example typical configuration on a CAN bus.

Silicon Labs' CAN operates at bit rates of up to 1 Mbit/second, though this can be limited by the physical layer chosen to transmit data on the CAN bus. The CAN processor has 32 Message Objects that can be configured to transmit or receive data. Incoming data, message objects and their identifier masks are stored in the CAN message RAM. All protocol functions for transmission of data and acceptance filtering is performed by the CAN controller and not by the CIP-51 MCU. In this way, minimal CPU bandwidth is needed to use CAN communication. The CIP-51 configures the CAN controller, accesses received data, and passes data for transmission via Special Function Registers (SFRs) in the CIP-51.

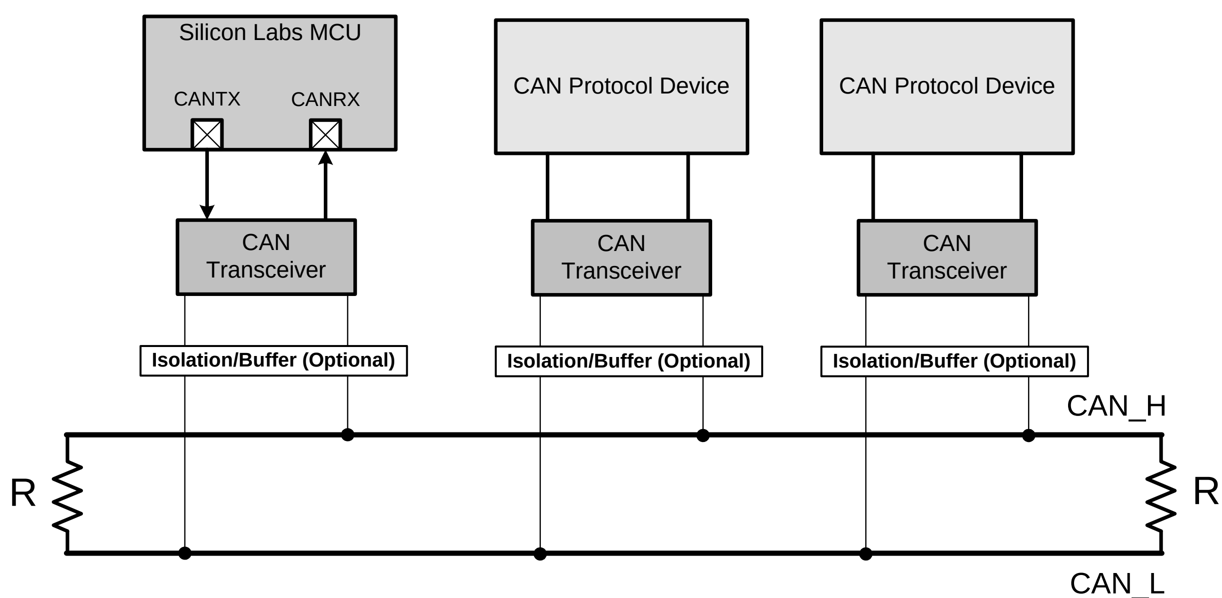

Figure 21.1. Typical CAN Bus Configuration

Table 21.2. Standard CAN Registers and Reset Values

CAN Addr.	Name	SFR Name (High)	SFR Addr.	SFR Name (Low)	SFR Addr.	16-bit SFR	Reset Value
0x50	IF2 Data A 2	CAN0IF2DA2H	0xFB	CAN0IF2DA2L	0xFA	CAN0IF2DA2	0x0000
0x52	IF2 Data B 1	CAN0IF2DB1H	0xFD	CAN0IF2DB1L	0xFC	CAN0IF2DB1	0x0000
0x54	IF2 Data B 2	CAN0IF2DB2H	0xFF	CAN0IF2DB2L	0xFE	CAN0IF2DB2	0x0000
0x80	Transmission Request 1[1]	CAN0TR1H	0xA3	CAN0TR1L	0xA2	CAN0TR1	0x0000
0x82	Transmission Request 2[1]	CAN0TR2H	0xA5	CAN0TR2L	0xA4	CAN0TR2	0x0000
0x90	New Data 1[1]	CAN0ND1H	0xAB	CAN0ND1L	0xAA	CAN0ND1	0x0000
0x92	New Data 2[1]	CAN0ND2H	0xAD	CAN0ND2L	0xAC	CAN0ND2	0x0000
0xA0	Interrupt Pending 1[1]	CAN0IP1H	0xAF	CAN0IP1L	0xAE	CAN0IP1	0x0000
0xA2	Interrupt Pending 2 [1]	CAN0IP2H	0xB3	CAN0IP2L	0xB2	CAN0IP2	0x0000
0xB0	Message Valid 1[1]	CAN0MV1H	0xBB	CAN0MV1L	0xBA	CAN0MV1	0x0000
0xB2	Message Valid 2[1]	CAN0MV2H	0xBD	CAN0MV2L	0xBC	CAN0MV2	0x0000

Notes:
1. Read-only register.
2. Write-enabled by CCE.
3. The reset value of CAN0TST could also be r0000000b, where r signifies the value of the CAN RX pin.
4. Write-enabled by Test.

22.5.2. Read Sequence (Master)

During a read sequence, an SMBus master reads data from a slave device. The master in this transfer will be a transmitter during the address byte, and a receiver during all data bytes. The SMBus interface generates the START condition and transmits the first byte containing the address of the target slave and the data direction bit. In this case the data direction bit (R/W) will be logic 1 (READ). Serial data is then received from the slave on SDA while the SMBus outputs the serial clock. The slave transmits one or more bytes of serial data. An interrupt is generated after each received byte.

Software must write the ACK bit at that time to ACK or NACK the received byte. Writing a 1 to the ACK bit generates an ACK; writing a 0 generates a NACK. Software should write a 0 to the ACK bit for the last data transfer, to transmit a NACK. The interface exits Master Receiver Mode after the STO bit is set and a STOP is generated. The interface will switch to Master Transmitter Mode if SMB0DAT is written while an active Master Receiver. Figure 22.6 shows a typical master read sequence. Two received data bytes are shown, though any number of bytes may be received. Notice that the ‘data byte transferred’ interrupts occur **before** the ACK cycle in this mode.

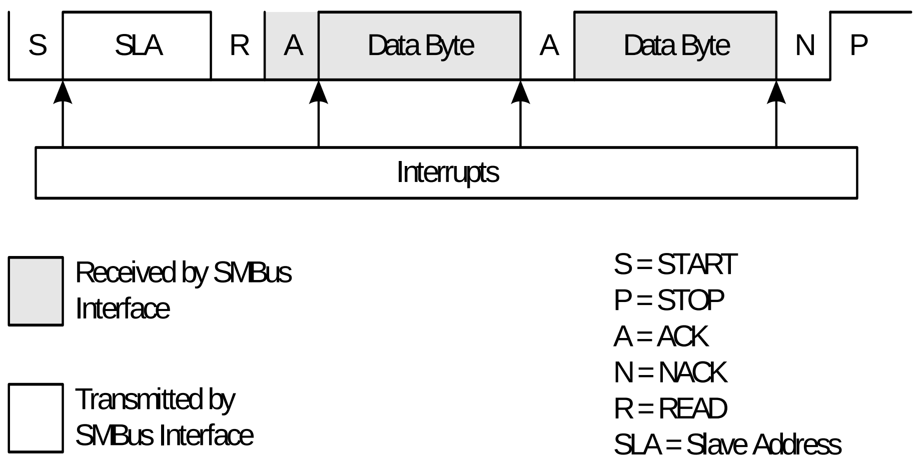

Figure 22.6. Typical Master Read Sequence

SFR Definition 25.11. TMR2L: Timer 2 Low Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2L[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xCC; SFR Page = 0x00

Bit	Name	Function
7:0	TMR2L[7:0]	**Timer 2 Low Byte.** In 16-bit mode, the TMR2L register contains the low byte of the 16-bit Timer 2. In 8-bit mode, TMR2L contains the 8-bit low byte timer value.

SFR Definition 25.12. TMR2H Timer 2 High Byte

Bit	7	6	5	4	3	2	1	0
Name	TMR2H[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xCD; SFR Page = 0x00

Bit	Name	Function
7:0	TMR2H[7:0]	**Timer 2 High Byte.** In 16-bit mode, the TMR2H register contains the high byte of the 16-bit Timer 2. In 8-bit mode, TMR2H contains the 8-bit high byte timer value.

26. Programmable Counter Array

The Programmable Counter Array (PCA0) provides enhanced timer functionality while requiring less CPU intervention than the standard 8051 counter/timers. The PCA consists of a dedicated 16-bit counter/timer and six 16-bit capture/compare modules. Each capture/compare module has its own associated I/O line (CEXn) which is routed through the Crossbar to Port I/O when enabled. The counter/timer is driven by a programmable timebase that can select between six sources: system clock, system clock divided by four, system clock divided by twelve, the external oscillator clock source divided by 8, Timer 0 overflows, or an external clock signal on the ECI input pin. Each capture/compare module may be configured to operate independently in one of six modes: Edge-Triggered Capture, Software Timer, High-Speed Output, Frequency Output, 8 to 11-Bit PWM, or 16-Bit PWM (each mode is described in Section “26.3. Capture/Compare Modules” on page 283). The external oscillator clock option is ideal for real-time clock (RTC) functionality, allowing the PCA to be clocked by a precision external oscillator while the internal oscillator drives the system clock. The PCA is configured and controlled through the system controller's Special Function Registers. The PCA block diagram is shown in Figure 26.1

Important Note: The PCA Module 5 may be used as a watchdog timer (WDT), and is enabled in this mode following a system reset. **Access to certain PCA registers is restricted while WDT mode is enabled**. See Section 26.4 for details.

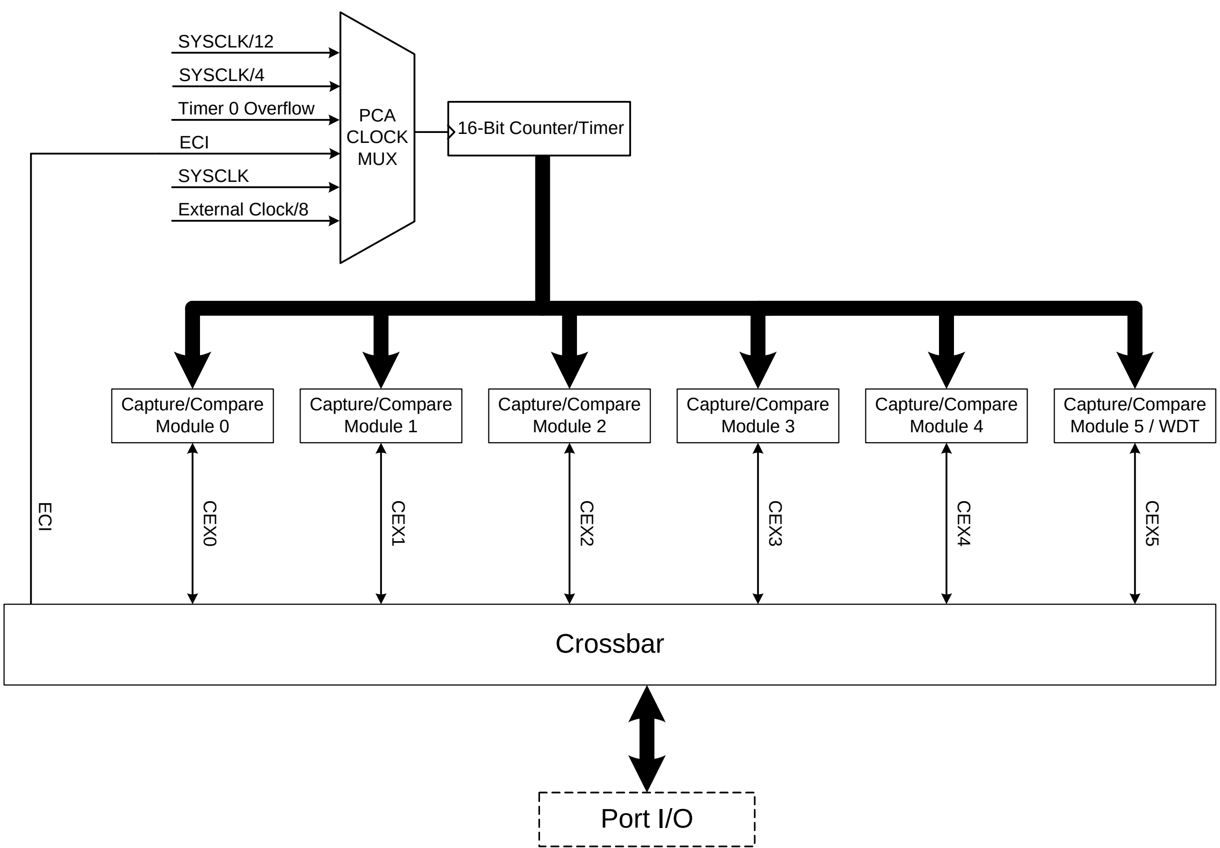

Figure 26.1. PCA Block Diagram

26.1. PCA Counter/Timer

The 16-bit PCA counter/timer consists of two 8-bit SFRs: PCA0L and PCA0H. PCA0H is the high byte (MSB) of the 16-bit counter/timer and PCA0L is the low byte (LSB). Reading PCA0L automatically latches the value of PCA0H into a “snapshot” register; the following PCA0H read accesses this “snapshot” register. **Reading the PCA0L Register first guarantees an accurate reading of the entire 16-bit PCA0 counter.** Reading PCA0H or PCA0L does not disturb the counter operation. The CPS[2:0] bits in the PCA0MD register select the timebase for the counter/timer as shown in Table 26.1.

When the counter/timer overflows from 0xFFFF to 0x0000, the Counter Overflow Flag (CF) in PCA0MD is set to logic 1 and an interrupt request is generated if CF interrupts are enabled. Setting the ECF bit in PCA0MD to logic 1 enables the CF flag to generate an interrupt request. The CF bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. Clearing the CIDL bit in the PCA0MD register allows the PCA to continue normal operation while the CPU is in Idle mode.

Table 26.1. PCA Timebase Input Options

CPS2	CPS1	CPS0	Timebase
0	0	0	System clock divided by 12.
0	0	1	System clock divided by 4.
0	1	0	Timer 0 overflow.
0	1	1	High-to-low transitions on ECI (max rate = system clock divided by 4).
1	0	0	System clock.
1	0	1	External oscillator source divided by 8.*
1	1	x	Reserved.

***Note:** External oscillator source divided by 8 is synchronized with the system clock.

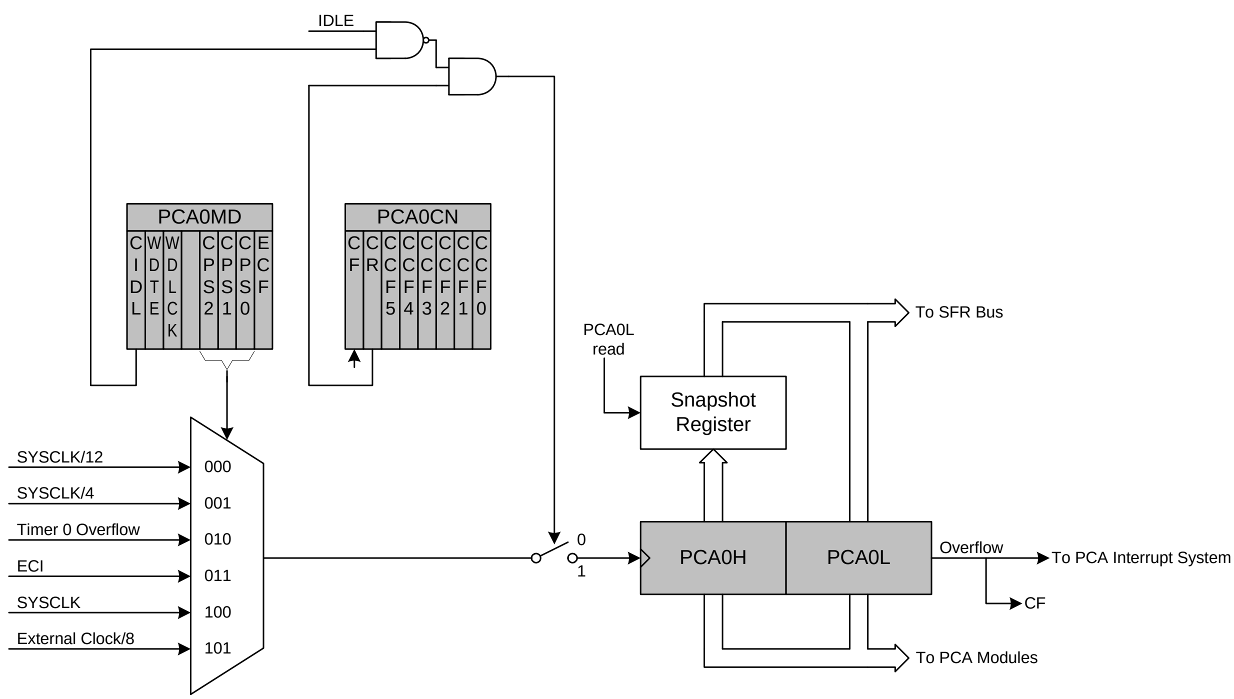

Figure 26.2. PCA Counter/Timer Block Diagram

C2 Register Definition 27.4. FPCTL: C2 Flash Programming Control

Bit	7	6	5	4	3	2	1	0
Name	FPCTL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

C2 Address: 0x02

Bit	Name	Function
7:0	FPCTL[7:0]	**Flash Programming Control Register.** This register is used to enable Flash programming via the C2 interface. To enable C2 Flash programming, the following codes must be written in order: 0x02, 0x01. Note that once C2 Flash programming is enabled, a system reset must be issued to resume normal operation.

C2 Register Definition 27.5. FPDAT: C2 Flash Programming Data

Bit	7	6	5	4	3	2	1	0
Name	FPDAT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

C2 Address: 0xB4

Bit	Name	Function	
7:0	FPDAT[7:0]	**C2 Flash Programming Data Register.** This register is used to pass Flash commands, addresses, and data during C2 Flash accesses. Valid commands are listed below.	
		Code	**Command**
		0x06	Flash Block Read
		0x07	Flash Block Write
		0x08	Flash Page Erase
		0x03	Device Erase